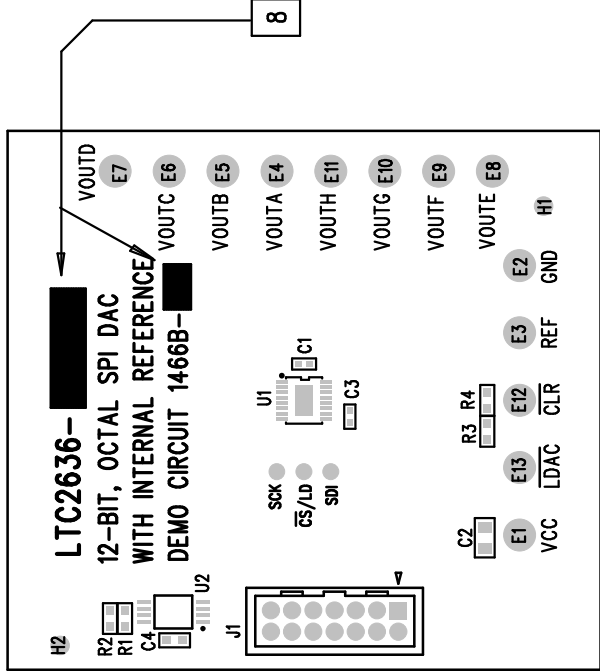


REVISION HISTORY			
ECO	REV	DESCRIPTION	APPR
1	1	PRODUCTION	Leo C.
			DATE
			10-10-12



TOP SILKSCREEN

LINEAR TECHNOLOGY CORP.

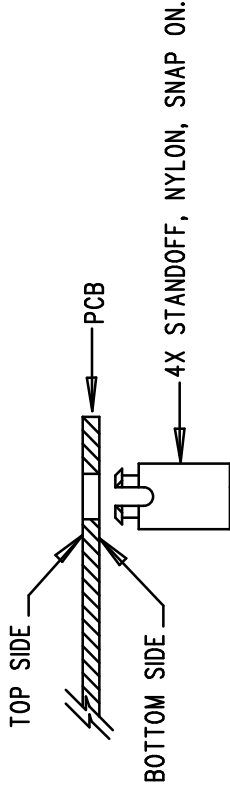
DC1466B


DATE: 10-10-12

8. THE VENDOR SHOULD ALSO MARK THE VERSION A OR B IN THE WHITE BLANK SPACE ON THE SILKSCREEN FOLLOWING THE BOM INSTRUCTION.

NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD. MAXIMUM SOLDER TEMPERATURE IS 240 DEGREES CELSIUS.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.
7. INSTALL 4 STANDOFFS AT 4 LOCATIONS AS SHOWN BELOW:



APPROVALS				1630 MCCARTHY BLVD MILPITAS, CA 95035 PH: (408)432-1900 www.linear.com LTC CONFIDENTIAL - FOR CUSTOMER USE ONLY	
PCB DES.	HZ				
APP ENG.	Leo C.				
		TITLE: TOP ASSEMBLY DRAWING			
		12-BIT, OCTAL SPI DAC WITH INTERNAL REFERENCE			
SIZE	IC NO.	LTC2636	FAMILY	REV.	
N/A		DEMO CIRCUIT 1466B		1	
SCALE = NONE		FILENAME: DC1466B-1.PCB		SHT 1 OF 1	